

## General Description

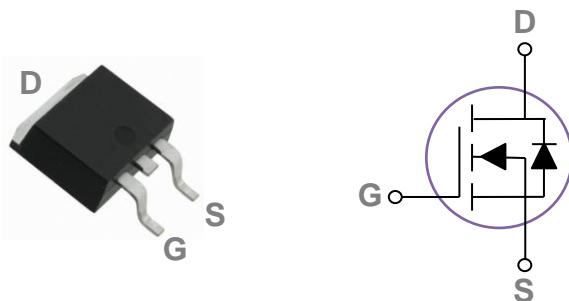
These N-Channel enhancement mode power field effect transistors are planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply

BVDSS	RDS(ON)	ID
600V	4.4Ω	2A

## Features

- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

## TO252 Pin Configuration



## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	600	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	2	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	1.3	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	8	A
EAS	Single Pulse Avalanche Energy	110	mJ
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	22.7	W
	Power Dissipation – Derate above $25^\circ\text{C}$	0.18	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	5.5	$^\circ\text{C}/\text{W}$

## Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	VGS=0V , ID=250uA	600	---	---	V
△BV <sub>DSS</sub> /△T <sub>J</sub>	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , ID=250uA	---	0.56	---	V/°C
IDSS	Drain-Source Leakage Current	VDS=600V , VGS=0V , TJ=25°C	---	---	1	uA
		VDS=480V , VGS=0V , TJ=125°C	---	---	10	uA
IGSS	Gate-Source Leakage Current	VGS=±30V , VDS=0V	---	---	±100	nA

### On Characteristics

R <sub>DSON</sub>	Static Drain-Source On-Resistance	VGS=10V , ID=1A	---	---	4.4	Ω
V <sub>Gsth</sub>	Gate Threshold Voltage	VGS=VDS , ID =250uA	2	---	4	V
gfs	Forward Transconductance	VDS=40V , ID=1A	---	2	---	S

### Dynamic and switching Characteristics

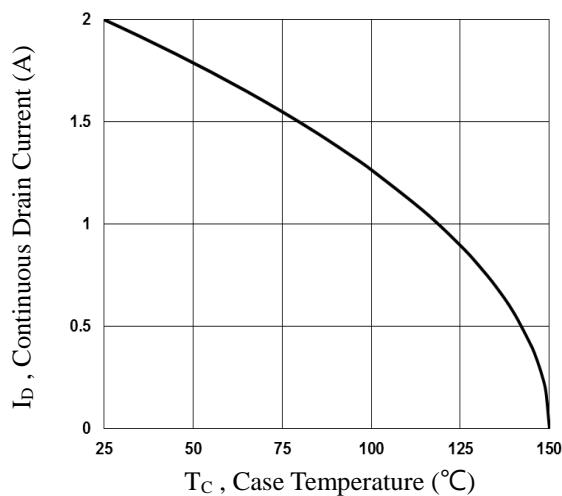
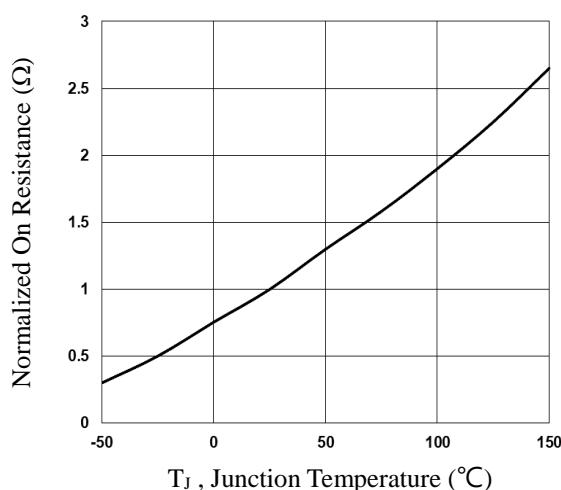
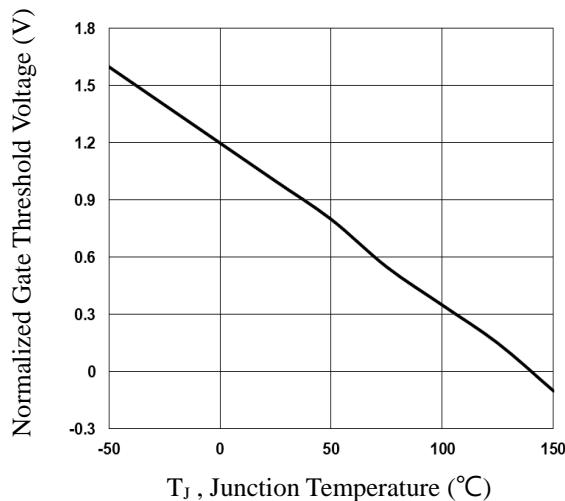
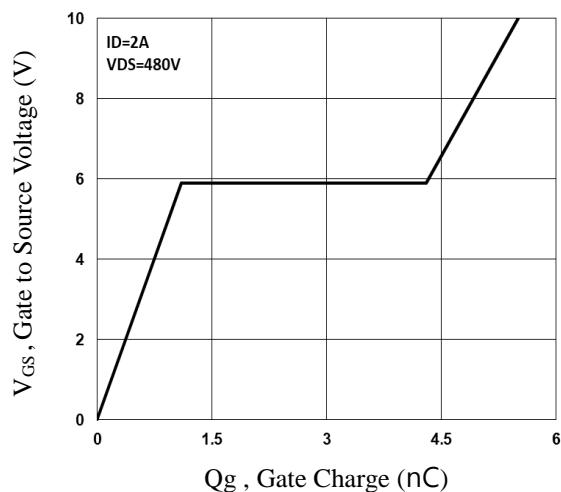
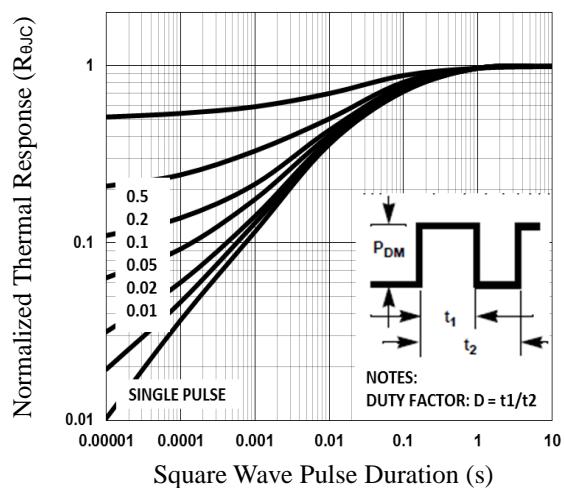
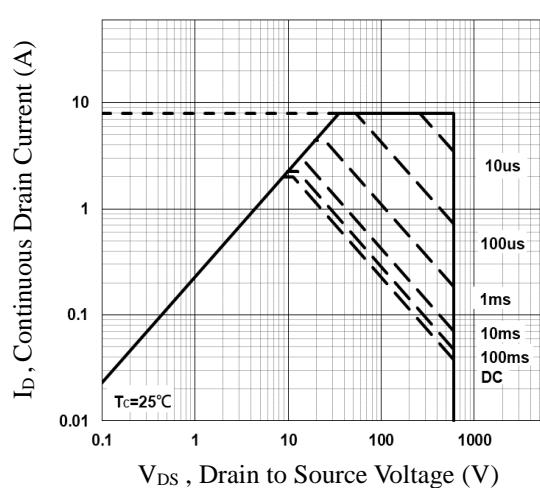
Q <sub>g</sub>	Total Gate Charge <sup>2,3</sup>	VDS=480V , VGS=10V , ID=2A	---	5.5	---	nC
Q <sub>gs</sub>	Gate-Source Charge <sup>2,3</sup>		---	1.1	---	
Q <sub>gd</sub>	Gate-Drain Charge <sup>2,3</sup>		---	3.2	---	
T <sub>d(on)</sub>	Turn-On Delay Time <sup>2,3</sup>	VDD=300V , VGS=10V , RG=25Ω ID=2A	---	17.2	23	ns
T <sub>r</sub>	Rise Time <sup>2,3</sup>		---	14.3	18	
T <sub>d(off)</sub>	Turn-Off Delay Time <sup>2,3</sup>		---	27.6	32.8	
T <sub>f</sub>	Fall Time <sup>2,3</sup>		---	17.4	19.8	
C <sub>iss</sub>	Input Capacitance	VDS=25V , VGS=0V , F=1MHz	---	238	---	pF
C <sub>oss</sub>	Output Capacitance		---	20	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	4	---	

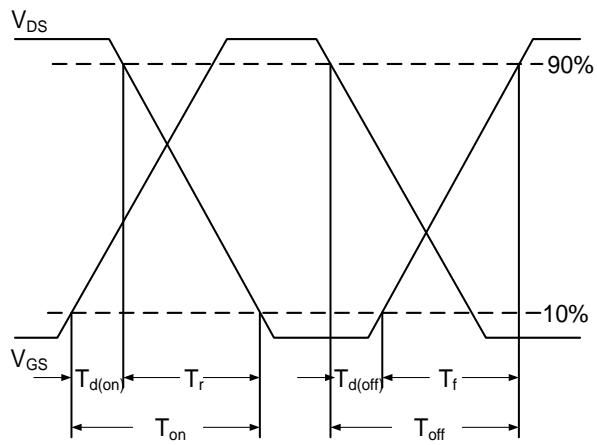
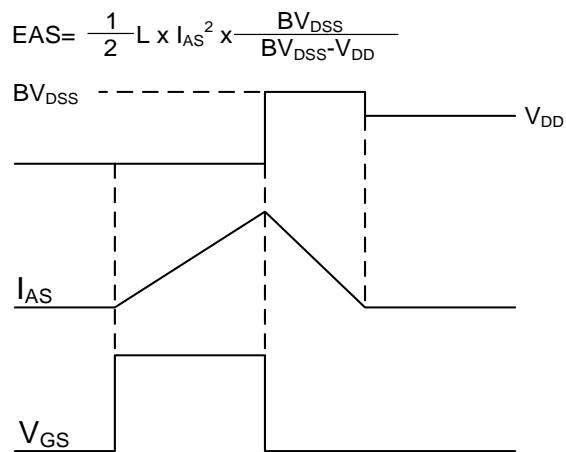
### Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>s</sub>	Continuous Source Current	VG=VD=0V , Force Current	---	---	2	A
I <sub>SM</sub>	Pulsed Source Current		---	---	4	A
V <sub>SD</sub>	Diode Forward Voltage	VGS=0V , Is=1A , TJ=25°C	---	---	1.5	V
t <sub>rr</sub>	Reverse Recovery Time <sup>2</sup>	VGS=0V,Is=2A , dI/dt=100A/μs TJ=25°C	---	154	189	nS
Q <sub>rr</sub>	Reverse Recovery Charge <sup>2</sup>		---	0.8	0.98	uC

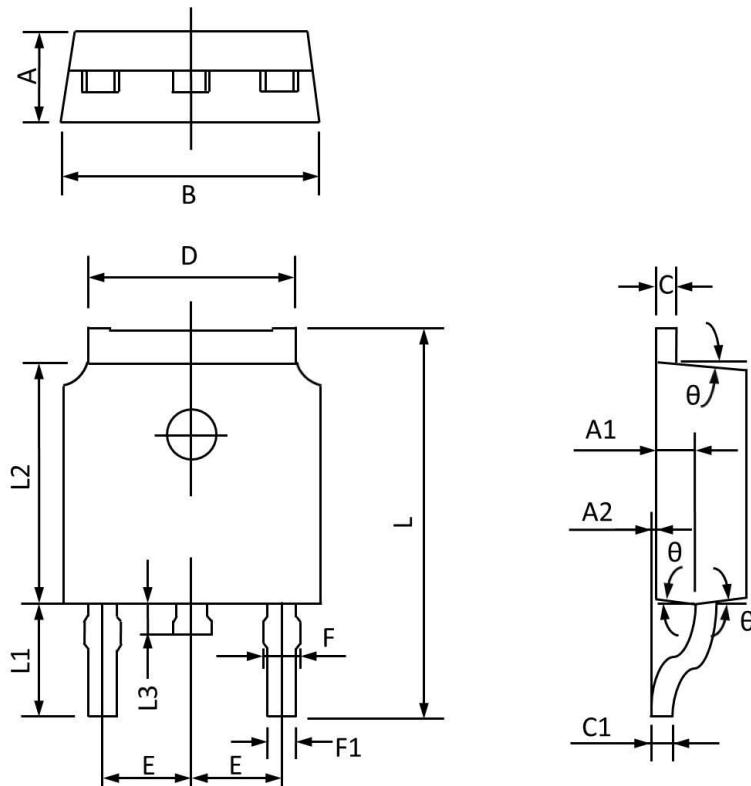
Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs.  $T_C$** 

**Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$** 

**Fig.3 Normalized  $V_{th}$  vs.  $T_J$** 

**Fig.4 Gate Charge Waveform**

**Fig.5 Normalized Transient Impedance**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 EAS Waveform**

## TO252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.400	2.200	0.094	0.087
A1	1.110	0.910	0.044	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.400	0.268	0.252
C	0.580	0.450	0.023	0.018
C1	0.580	0.460	0.023	0.018
D	5.500	5.100	0.217	0.201
E	2.386	2.186	0.094	0.086
F	0.940	0.600	0.037	0.024
F1	0.860	0.500	0.034	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.200	5.400	0.244	0.213
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°